



2 Lead Metal Package Quartz Crystal, 4.7 mm x 11 mm



HC49US Series

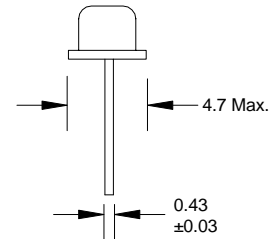
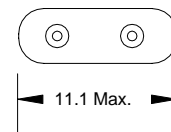
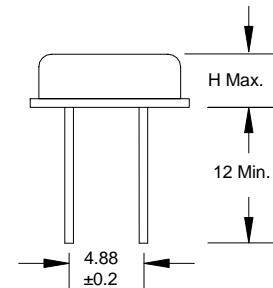
Product Features:

Low Cost Package
RoHs Compliant
Compatible with Leadfree Processing

Applications:

Fibre Channel
Server & Storage
Sonet /SDH
802.11 / Wifi
T1/E1, T3/E3

Frequency	3.2 MHz to 100.000 MHz
ESR (Equivalent Series Resistance)	
3.2 MHz – 3.49 MHz	300 Ω Max.
3.5 MHz – 3.99 MHz	200 Ω Max.
4.0 MHz – 4.99 MHz	150 Ω Max.
5.0 MHz – 5.99 MHz	120 Ω Max.
6.0 MHz – 6.99 MHz	100 Ω Max.
7.0 MHz – 8.9 MHz	80 Ω Max.
9.0 MHz – 12.9 MHz	60 Ω Max.
13 MHz – 19.9 MHz	40 Ω Max.
20 MHz – 36 MHz	30 Ω Max.
27 MHz – 100 MHz (3 rd O.T.)	100 Ω Max.
Shunt Capacitance (C0)	7 pF Max.
Frequency Tolerance @ 25° C	\pm 30 ppm Standard (see Part Number Guide for more options)
Frequency Stability over Temperature	\pm 50 ppm Standard (see Part Number Guide for more options)
Crystal Cut	AT Cut Standard
Load Capacitance	18 pF Standard (see Part Number Guide for more options)
Drive Level	1 mW Max.
Aging	\pm 5 ppm Max. / Year Standard
Temperature	
Operating	0° C to +70° C Standard (see Part Number Guide for more options)
Storage	-40° C to +85° C Standard



HC49US, H Max. = 3.5
HC49US2, H Max. = 2.5
HC49US3, H Max. = 2.0

Dimension Units: mm

Part Number Guide		Sample Part Number: HC49US - FB1F18 - 20.000				
Package	Tolerance (ppm) at Room Temperature	Stability (ppm) over Operating Temperature	Operating Temperature Range	Mode (overtone)	Load Capacitance (pF)	Frequency
HC49US - (3.5 mm H) HC49US2 - (2.5 mm H) HC49US3 - (2.0 mm H)	B = \pm 50 ppm	B = \pm 50 ppm	0 = 0°C to +50°C	F = Fundamental	18 pF Standard Or Specify	- 20.000 MHz
	F = \pm 30 ppm	F = \pm 30 ppm	1 = 0°C to +70°C	3 = 3 rd overtone		
	G = \pm 25 ppm	G = \pm 25 ppm	2 = -10°C to +60°C			
	H = \pm 20 ppm	H = \pm 20 ppm	3 = -20°C to +70°C			
	I = \pm 15 ppm	I = \pm 15 ppm**	5 = -40°C to +85°C			
	J = \pm 10 ppm*	J = \pm 10 ppm**	9 = -10°C to +50°C			

* Not available at all frequencies. ** Not available for all temperature ranges.



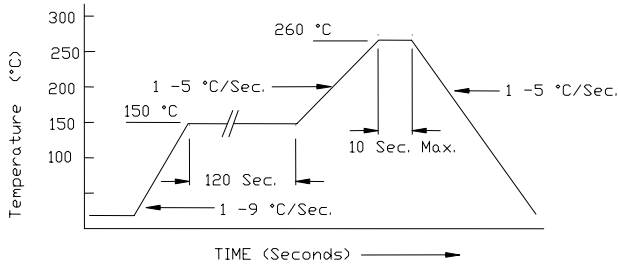
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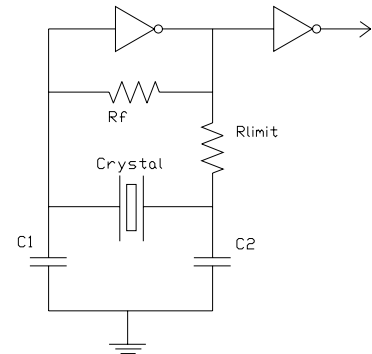
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Pb Free Solder Reflow Profile:

Typical Circuit:



*Units are backward compatible with 240C reflow processes



Package Information:

MSL = 1
Termination = e1 (Sn / Cu / Ag over Ni over Kovar base metal).

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

Marking

Line 1 ILSI, Frequency, Date Code (yww)